Stanley dot matrix character type LCD module



GMD1620B GMD1621B

OVERVIEW

Stanley Dot Matrix Module GMD162*B (16 characters \times 2 line) consists of LC display, C-MOS driver and C-MOS LSI to control.

The module utilizes 5x7 dot matrix characters to provide full alphanumeric capability. All control, refresh and display functions are executed by a dedicated on-board controller. The module is capable of displaying the full 160-character font set.

Data interfacing is via 8-bit bi-directional data bus or a 4-bit one.

By use of simple control commands, data can be selectively written to (or read from) any cursor location and arbitrary fonts can be written to CHARACTER GENERATOR RAM.

It comes in various variations shown below:

GMD 1 6 2 0 B
GMD 1 6 2 1 B
best viewing angle at 6 o'clock
best viewing angle at 12 o'clock

FEATURES

- Control LSI built in. (Control commands: Display clear, Return home, Cursor preset, etc...)
- •5×7 dot matrix with cursor.
- · Character Generator ROM built in.

5 x 7 font ; Alphanumeric-----96characters

Japanese-----64characters

• Character Generator RAM(Customer rewritable)

5x7 font ; 8 characters

compliance with the RoHS directive (issued on February 2003).

PRODUCT SPECIFICATION

ltem	Specification	Unit
Number of characters	16character(width) × 2LINE(height)	-
Dimensions	85.0(width) X 36.0(height) X 10.5(thickness)	mm
Effective display area	63.5(width) X 15.8(height)	mm
Characters size	3.20(width) X 5.55(height)	mm
Dot pitch	0.65(width) X 0.70(height)	mm
LCD mode *1 (Positive image)	TN mode Reflective type	-
Duty ratio	1/16	duty
Back light unit	-	-
Interface	4-bit or 8-bit parallel MPU	-
Weight	approx. 30	g

^{*1:} A property of liquid crystal, as seen in this LCD panel, is that it's color tone changes with variations in ambient temperature.

ABSOLUTE MAXIMUM RATINGS

ENVIRONMENTAL CONDITIONS

lte	em	Mini	mum		Maximur	n	Remarks
Ambient	Operating	0			+50		-
Temperature (= T a)	Storage	-20			+70		-
Humidity				*	1		There must be no condensation
Vibration		Conforms to JIS			C 60068-2-6	: 1999	Refer to Reliability Testing
Mechanical Shock		Conforms to JIS			C 60068-2-27	7:1995	Refer to Reliability Testing
Corrosive Ga	There	must	be r	no corrosive	gas	-	

^{*1:} Ta +40 - - - - 90%RH max.

Ta > +40 - - - - The absolute humidity must be less than 90%RH at Ta = +40°C.

ELECTRICAL CONDITIONS

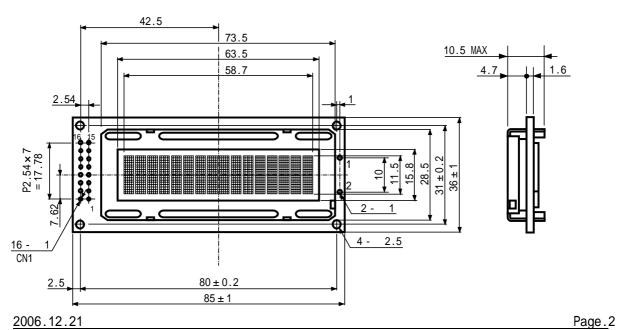
 $(Ta=0 \sim +50)$

Item	Symbol	Minimum	Maximum	Unit	Remarks
Power Supply for Logic	VDD-VSS	0	7.0	V	
Input Voltage for Logic	VI	VSS	VDD	V	
Operating Voltage for LCD Driving	VDD-VEE	0	13.0	V	

OUTER DIMENSIONS

The tolerance without instruction is ± 0.5 mm

 $\label{prop:frame color : black} Frame \ color : black$



STANLEY ELECTRIC CO.,LTD.

ELECTRICAL SPECIFICATIONS

ELECTRICAL CHARACTERISTICS - LCD OPERATION

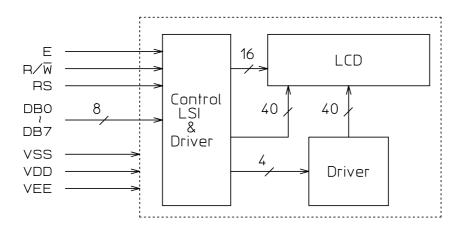
 $(Ta=0 \sim +50 , duty=1/16)$

Item	Symbol	Minimum	Typical	Maximum	Unit	Remarks
Power Supply for Logic	VDD-VSS	4.75	5.0	5.25	V	-
Input "High" Voltage	VIH	2.2	-	VDD	V	-
Input "Low" Voltage	VIL	-0.3	-	0.6	V	-
Output "High" Voltage	VOH	2.4	-	-	V	*1
Output "Low" Voltage	VOL	-	-	0.4	V	*2
Power Supply current	IDD	-	1.0	3.0	mA	*3
Operating Voltage for LCD Driving	VDD-VEE	3.0	-	11.0	V	-

*1:-IOH=0.205mA *2:IOL=1.2mA

*3: VDD-VSS=5V

BLOCK DIAGRAM

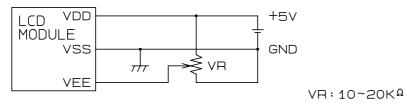


DD RAM ADDRESS

/		1	2	3	4	5	 12	13	14	15	16
	LINE1	00	01	02	03	04	0B	00	OD	0E	0F
	LINE2	40	41	42	43	44	4B	4C	4D	4E	4F

RAM AREA : $00H \sim 27H$ & $40H \sim 67H$ (HEX)

EXAMPLE OF POWER SUPPLY



ELECTRICAL CHARACTERISTICS - TERMINAL FUNCTIONS CON1.CON2

Pin No.	Signal	1/0	Funct i on
1	VSS	-	GND: 0V
2	VDD	-	+5V
3	VEE	-	LCD driving voltage
4	R S	I	Signal to select registers "0": Instruction register (for write) Busy flag; address counter (for read) "1": Data register (for read and write)
5	R/W	I	Signal to select read (R) and write (W) "O": write MPU LCD Module "1": Read MPU LCD Module
6	E	I	Operation start signal for data read or write.
7	DB0		Data bus of lower 4 bits having bi-directional
8	D B 1	I/O	port. Used for data transfer between the MPU and
9	D B 2	170	the module. These four are not used during 4bit
1 0	D B 3		operation.
1 1	D B 4		
1 2	D B 5	I/0	Data bus of higher 4 bits having bi-directional
1 3	DB6	170	port. Used for data transfer between the MPU and the module. DB7 can be used as a BUSY flag.
1 4	D B 7		
1 5	NC *1	-	Not connected
1 6	NC *1	-	Not connected

NOTE: In the module, the data can be sent in either 4-bit 2-operation or 8-bit 1-operation so that it can interface to both 4 and 8 bit MPU's.

- 1) When interface data is 4bits long, data is transferred using only 4 buses of DB4 ~ DB7 and DB0 ~ DB3 are not used.

 Data transfer between the module and the MPU complete when 4-bit data is transferred twice. Data of the higher 4bits(contents of DB4 ~ DB7 when interface data is 8bits long) is transferred first and lower 4bits (contents of DB0 ~ DB3 when interface data is 8bits long).
- 2) When interface data is 8bits long, data is transferred using 8 data buses of DBO ~ DB7.
- *1: No.15 and No.16 pins are not used in this produt. CON2 has No.1 to No.14, does not have No.15 and No.16.

OPTICAL CHARACTERISTICS

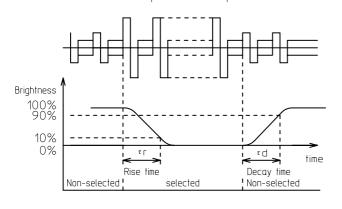
CHARACTERISTICS OF THE LCD PANEL

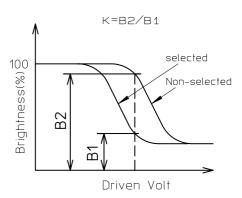
Item	Symbol	Minimum	Typical	Maximum	Unit	Temp.	Condition
Operating Voltage		3.4	3.7	-	V	50	=20 ° , =0 °
for LCD Driving	VDD-VEE	-	4.3	-	V	25	=20 ° , =0 °
(1/16duty)		-	4.8	5.0	V	0	=20 ° , =0 °
Rise response time	r	-	95	190	ms	25	=20 ° , =0 ° * 1
Fall response time	d	-	150	300	ms	25	=20 ° , =0 ° * 1
Contrast ratio	K	3	ı	-	ı	25	=20 ° , =0 ° * 2
Range of	1- 2	20	ı	-	0	25	=0 ° ,K=1.4 * 3
viewing angle		± 30	ı	-	0	25	=20 ° ,K>1.4 * 3

*) Measured for LCD panel alone. If heat sources (LEDs, CCFLs, etc) exist in the vicinity, the associated temperature increase must be taken into consideration.

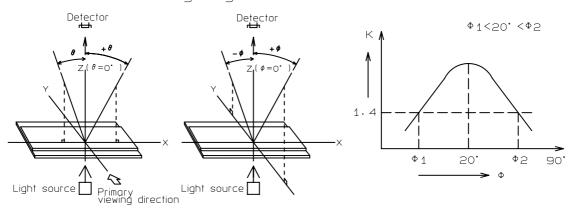
(1)Definition of optical response(*1)

(2)Definition of contrast(*2)





(3)Definition of Viewing angle(*3)



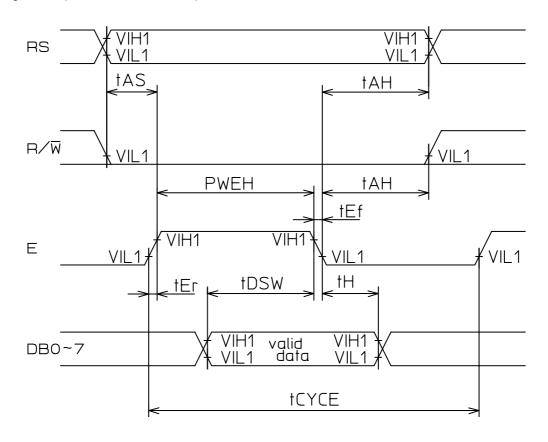
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TIMING CHARACTERISTIC

WRITE OPERATION

Item	Symbol	Measuring condition	Minimum	Typical	Maximum	Unit
Enable cycle time	tCYCE	Refer to the figure	500	-		nsec
Enable pulse width	PWEH	Refer to the figure	230	-	-	nsec
Enable rise time	tEr	Refer to the figure	-	-	20	nsec
Enable fall time	tEf	Refer to the figure	-	-	20	nsec
Set-up time	tAS	Refer to the figure	40	-	-	nsec
Address hold time	t AH	Refer to the figure	10	-	-	nsec
Data set-up time	t DSW	Refer to the figure	80	-	-	nsec
Data hold time	tH	Refer to the figure	10	-	-	nsec

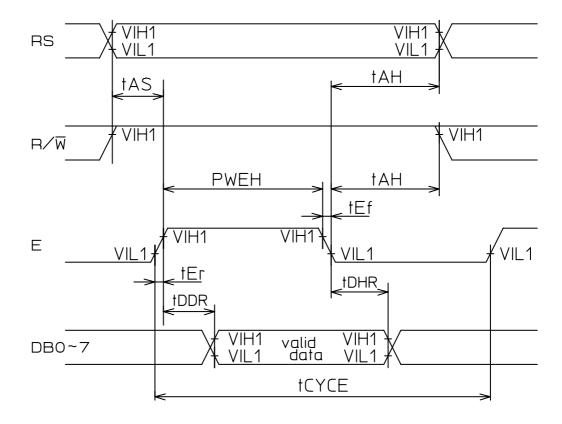
Writing Data (from MPU to Module)



READ OPERATION

Item	Symbol	Measuring condition	Minimum	Typical	Maximum	Uni t
Enable cycle time	tCYCE	Refer to the figure	500	-	-	nsec
Enable pulse width	PWEH	Refer to the figure	230	-		nsec
Enable rise time	tEr	Refer to the figure	-	-	20	nsec
Enable fall time	tEf	Refer to the figure	-	-	20	nsec
Set-up time	tAS	Refer to the figure	40	-		nsec
Address hold time	t AH	Refer to the figure	10	-		nsec
Data delay time	t DDR	Refer to the figure	-	-	120	nsec
Data hold time	t DHR	Refer to the figure	5	-		nsec

Reading Data (from Module to MPU)



INSTRUCTIONS

Instructions

Execution	time (max)	dress 1.52mS	unter Iginal 1. 52mS Iged.	shift 90 µS	sor 90 #S	out 90 µS	of 90 #S	sent 90 #S	sent 90 #S	lds 0 uS	.M. 90 #S		4M. GO#3		+	<u>-</u>	<u> </u>	5 8	
	טופרויטווסון	Clears entire display and sets DD RAM address 0 in address counter.	Sets DD RAM address 0 in address counter. Also, returns display, being shifted to original position.DD RAM contents Temain unchanged.	Sets cursor move direction and specifies shift of display. These operations are performed during data write and read.	Sets ON/OFF of entire display(D).cursor ON/OFF(Cand blink of cursor position Character(B).	Moves cursor and shifts display without changing DD RAM contents.	Sets interface data length(DL),number display lines(L) and character font(F).	Sets CG RAM address,CG RAM data is sent and received after this setting.	Sets DD RAM address,DD RAM data is sent and received after this setting.	Reads, Busy, flag(BF)indicating internal operation is being performed and reads address counter contents.	Writes data into DD RAM or CG RAM.	Reads data from DD RAM or CG RAM.		DD RAM : Display data RAM. CG RAM : Character generator RAM.	DD RAM : Display data RAM. CG RAM : Character generator RAM. ACG : CG RAM address. ADD : DD RAM address.	DD RAM : Display data RAM. CG RAM : Character generator RAM. ACG : CG RAM address. ADD : DD RAM address. Corresponds to cursor address.	DD RAM : Display data RAM. CG RAM : Character generator RAM. ACG : CG RAM address. ADD : DD RAM address. Corresponds to cursor address. AC : Address counter used for both	DD RAM: Display data RAM. CG RAM: Character generator RAM. ACG: CG RAM address. ADD: DD RAM address. Corresponds to cursor address. AC: Address counter used for both DD	DD RAM: Display data RAM. CG RAM: Character generator RAM. ACG: CG RAM address. ADD: DD RAM address. Corresponds to cursor address. AC: Address counter used for both and CG RAM address.
	1 DB0	1	*	υ O	В	*	*												I/D=1: Increment , I/D=0 : Decrement S=1: Accompanies display shift S/C=1 : Display shift , S/C=0 : Cursor move R/L=1 : Shift to the right , R/L=0 : Shift to the left DL=1 : 8bits , DL=0 : 4bits N=1 : Zlines , N=0 : 1line F=1 : Sx10dots , F=0 : 5x7dots
	2 DB 1	0	1	1/D	O	*	*								e left	e leff	e left	e leff	e leff
	3 DB2	0	0	Τ		B/L	ш	ACG			Data	ta		a 20	ove to th	ove to th	ove to th	ove to th	ove to th
	DB3	0	0	0	1	S/C	Z	◁	ADD	AC		Data		TE 105	sor m Shiff	sor m	sor m Shift	sor m Sorm: Shift	sor m
Code	DB4	0	0	0	0	1	Ы				Write	Read		shift Shift	ecreme shift : Cur	ccreme shift : Cur	ecreme shift : Cur :/L=0	ecreme shift : Cur ?/L=0	screme shift : Cur ?/L=0
	DB5	0	0	0	0	0	7				W	m m		:0 : De play s S/(=0	:0 : De play s S/C=0 Jht , F	:0 : De play s S/C=0 Jht , F bits	:0 : De play s S/C=0 Jht , F bits 	:0 : De play s S/C=0 S/C=0 Jht , F Jht , F Jhts Pe	o: De play s S/C=0 S/C=0 jht , R jht , R Sy/d
	DB6	0	0	0	0	0	0	1						, I/D= es dis shiff	es dis shift , the ric	, I/D= es dis shift , shift , the ric	, I/D= es dis shift , the ric the cic =0:4	, I/D= es dis shift , the ric the ric the ric the ric T=0 : 4	, I/D= es dis shift , the ric the ric the ric T=0 : 4
	DB7	0	0	0	0	0	0	0	1	BF				1/D=1: Increment , 1/D=0 : Decrement S=1: Accompanies display shift S/C=1: Display shift S/C=0 : Curso	rement ompani splay iift to	rement ompani splay init to ts, Dl	1/D=1: Increment, 1/D=0: Decrement S=1: Accompanies display shift S/C=1: Display shift, S/C=0: Cursor move R/L=1: Shift to the right, R/L=0: Shift to the left DL=1: 8bits, DL=0: 4bits N=1: Zlines, N=0: 1(ines)	rement ompani splay inft to ts , DL ss , N=	I/D=1: Increment, I/D=0: Decre S=1: Accompanies display shift S/C=1: Display shift, S/C=0: (R/L=1: Shift to the right, R/L= DL=1: 8bits, DL=0: 4bits N=1: Zlines, N=0: 4line P=1: Sx/dots, F=0: 5x/dots
	R/W	0	0	0	0	0	0	0	0	1	0	4		1 : Incr : Acc(=1 : Dis	1 : Incr : Accr =1 : Dis =1 : St	1 : Incl : Accc :1 : Dis :1 : St :2 : St :2 : St	1: Incr : Accc :1: Dis :1: St 1: 8bil : 2line	1 : Inci : Accc :1 : Dis :1 : Sh 1 : 8bii : 2line : 5x10	1: Inco : Accc :1: Dis :1: Sh 1: 8bii : 2line : 5x10
	RS	0	0	0	0	0	0	0	0	0	1	4		- - - - - - - - - - - - -		/0 S=1 S/C_ P 1	 S -2 S -2 S -1 S -		
() () () ()		Clear Display	Return Home	Entry Mode Set	Display ON/OFF Control	Cursor or Display Shift	Function Set	Set CG RAM Address	Set DD RAM Address	Read Busy flag & Address	Write Data to CG or DD RAM	Read Data from CG or DD RAM							

RELATIONSHIP BETWEEN CG RAM ADDRESS AND CHARACTER CODE (DD RAM DATA) TO CHARACTER PATTERN (CG RAM DATA)

Character Code (DD RAM Data) Character Pattern (CG RAM Data) CG RAM Address 76543210 Upper bits,Lower bits 543210 Upper bits,Lower bits 76543210 Upper bits, Lower bits ***11110 000 10001 001 10001 010 Character 000 011 11110 pattern 0000*000 exanple(1) 100 10100 10010 101 10001 110 >position ***00000 1 1 1 ***10001 000 01010 001 11111 010 Character 001011 }paffern 0000*001 exanple(2) 100 11111 00100 101 00100 110 {cursor 111 ***00000 *** :000 001 111 100 0000*111 101 110 1 1 1 ***

(For 5×7 dot character patterns)

* : Don't Care

NOTES

- 1. Character code bits 0-2 correspond to CGRAM address bits 3-5 (3bits: 8 characters).
- 2. CGRAM address bits 0-2 designate character pattern line position. The 8th line is the cursor position and display is performed in logical OR the cursor. Maintain the 8th line data, corresponding to the cursor display position in the "0", state for cursor display. When the 8th line data is "1", bit 1 lights up regardless of cursor existence.
- 3. Character pattern row positions correspond to CGRAM data bits 0-4, as shown in the figure (bit 4 being at the left end).
 Since CGRAM data bits 5-7 are not used for display, these can be used for the general data RAM.
- 4. As shown in the table above, the CGRAM character patterns are selected when character code bit 4-7 are all "0". However, since character code bit 3 is an ineffective bit, the "R" display in the character pattern example, is selected by character code "00" (hexadecimal) or "08" (hexadecimal).
- 5. "1" for CGRAM data corresponds to selection for display and "0" for no selection.

CORRESPONDENCE BETWEEN CHARACTER CODES AND CHARACTER PATTERN

Higher													
Higher 4bit Lower 4bit	0000	0010	0011	0100	0101	0110	0111	1010	1011	1100	1101	1110	1111
XXXX0000	CG RAM (1)					"	1				88 88 88		
XXXX0001	(2)	8						B					
XXXX0010	(3)	88						-	4				
XXXX0011	(4)				6 1		-000 -000 -000						####
XXXX0100	(5)									0000			
XXXX0101	(6)	BB				8000 80008		88					
XXXX0110	(7)									000		8-36	
XXXX0111	(8)	#								8888			
XXXX1000	(1)				8,8			4					
XXXX1001	(2)	0000					B			0			
XXXX1010	(3)		BB BB		86666							- Brood -	
XXXX1011	(4)		88 88				8					24	
XXXX1100	(5)	8	666				00000		888				
XXXX1101	(6)	00000	00000					88		~~ ₈	8 8	-888	
XXXX1110	(7)	BB	80°00							8 8 8			
XXXX1111	(8)				00000		₩.	888	L				

RESET FUNCTION

The module automatically performs initialization (reset) when power is turned on. (using internal reset circuit) The following instructions are executed in initialization. The BUSY FLAG is kept in the busy state (BF=1) until initialization ends. The time is 15 ms.

1) Clear display

2) Function set

DL=1: 8 bits long interface data

N =0: 1-line display

F =0: 5x7 dot character font

3) Display ON/OFF control

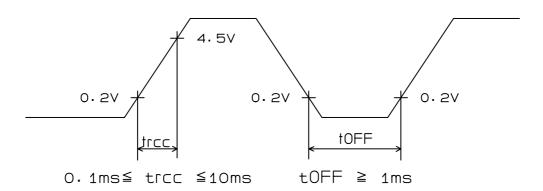
D =0: Display OFF C =0: Cursor OFF B =0: Blink OFF

4) Entry mode set

I/D=1: +1 (increment)
S =0: No shift

5) DDRAM selected

Because initialization may not be performed completely depending on the rise time of the power supply when it is turned on, pay attention to the following time relationship.



tOFF stipulates the time of power OFF for power supply instantaneous dip or when power supply repeats ON and OFF.

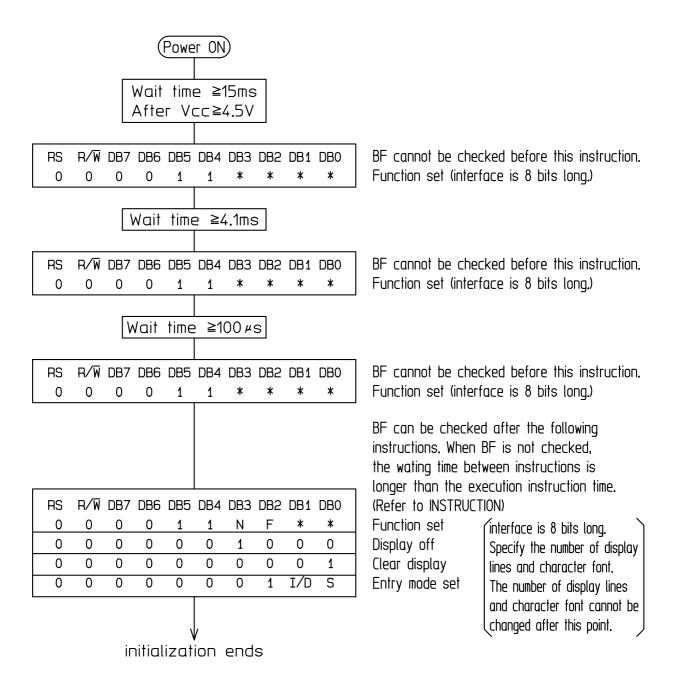
NOTES

When the above power supply condition is not satisfied, the internal reset circuit does not operate normally.

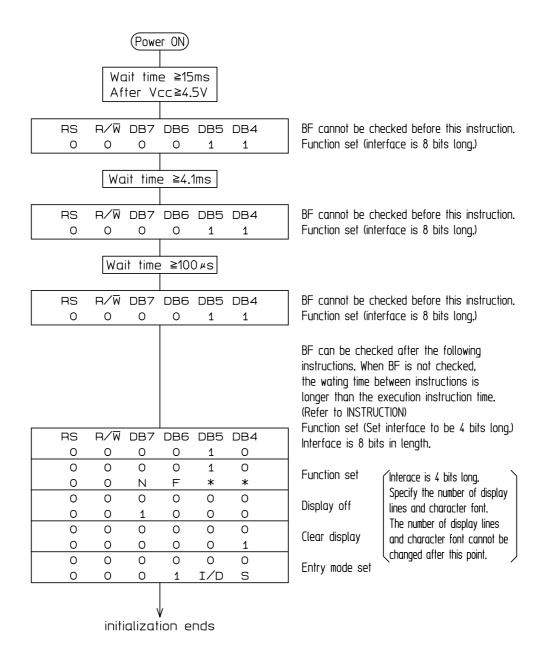
INITIALIZING BY INSTRUCTION

If the power supply conditions for correctly operating the internal reset circuit are not met, initialization by instructions becomes necessary.

8-BIT INITIALIZATION



4-BIT INITIALATION



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RELIABILITY TESTING

Items of Reliability Testing

	or Kerrability restr		
No.	Test item	Test condition	Test hours
1	Operation in high temperature	Ta = +50°C all display on (standard operation)	240hours
2	Shelf test in high temperature	Ta = +70°C (no operation)	240hours
3	Shelf test in low temperature	Ta = -20°C (no operation)	240hours
4	High-temperature, high-humidity test	Ta = +40°C,RH=90% (no operation)	240hours
5	Temperature cycle test	-20 (30min.) +25 (5min.) +70 (30min) +25 (5min.) ←	10cycles
6	Vibration test	Frequency range:10 ~ 55Hz Total amplitude:1.5mm Sweep ratio :10 ~ 55 ~ 10 about 1 minute Standard :JIS C 60068-2- 6:1999 (no operation)	2 hours for each direction of x, y and z (total 6 hours)
7	Mechanical shock	Peak acceleration: 50 x 9.8 m/s2 Length of impact application: 11msec Half sine wave Standard: JIS C 60068-2-27:1995 (no operation)	3 times for each direction of ±X, ±Y and ±Z

Criteria

Visually check the display quality using an LCD module inspection tool.

- a) Miss or no function of display.b) Damaging or deforming of components.



Instruction of use

Handling precautions

- •Extra care must be exercised to protect it from a mechanical impact or shock.

 Because the LC panel is made of glass, it may be broken if a strong impact is applied to it.
- •The polarizer on the surface of the display gets scratched easily. Do not press such as tweezers, tools or other hard materials against the polarizer, and do not scratch the polarizer with them.
- •The polarizer may be damaged if it comes into contact with an organic solvent. If the display surface becomes stained, remove the stain by applying cellophane tape, or wipe the display surface lightly using a soft cloth, such as an absorbent cotton cloth with diluted neutral detergent.
- If water drops adhere to the display surface for a long time, they cause discoloring or will become unremovable stains. If these are found on the display surface, wipe them off immediately.
- •The liquid (liquid crystal) inside the liquid crystal panel is a harmful substance. If the liquid crystal panel is broken, do not put the spilled liquid crystal in the mouth, and if adhere to the skin or clothes, apply soap and wash is away.
- •To prevent damage of LSI and LED by static electricity, do electrostatic measures such as earth bands when you remove the protection film from LCD panel.
- This product is designed for use in air-conditioned, no vibrated and no impacted indoors. And this product has to be used above condition.
- •Films such as heat seal and TCP(Tape Carrier Package) are used in the LCD module. When using the LCD module, pay extra attention to avoid damaging the films. If film is damaged, it causes malfunction display.
- The following LCD modules uses rubber connector (conducting elastomer). Do not warp or twist at handling.

Pertinent products:

GMD1620B, GMD1621B, GMD1620BLY, GMD1621BLY, GMD1620BSLY, GMD1621BSLY, GMD2020B, GMD2021B, GMD2020BLY, GMD2021BLY, GMD2020BSLY, GMD2021BSLY, GMF32024ABTW, GMF32024BSLY, GMF64020ABTW

Storage precautions

- •Do not storage or use the LCD module at high temperature and high humidity. If stored or used at high temperature and humidity, air bubbles may occur or the polarizer may peel off from the surface. When storing the LCD module, put it in an electrically-conductive plastic bag or delivered package, and store it at low temperature (+5 to +30), at low humidity (RH= 30 to 70%) and not in direct sunlight or fluorescent light.
- •Use the pure water or distilled water when you use the humidifier to prevent dryness. Do not use tap water because it includes chlorine and it may damage module.
- Do not store at high temperature such as in direct sunlight or near heating facility.
- Do not store at rapid temperature change's place such as in direct sunlight or strong lightings, because it causes condensation. Pleas store it in constant temperature place.
- Store at no dust, no corrosive gas (exhausting, smoke, NOx and SOx included in chemical, and so on) and no salinity condition.
- •Do not expose to radiation, static electricity and strong magnetic field.

Operating precautions

- Do not connect it to or disconnect it from the main system when the LCD module is powered on.
- If the LCD module is stored at temperatures below or above the specified storage temperature limits, it may be malfunction and it may not be restored even after the temperature is adjusted to the specified storage temperature.
- •Optical characteristics (viewing angle and contrast ratio) are depended on LCD driving voltage. Please adjust it to achieve optimum contrast ratio in each module.

Driving voltage (VDD-Vo):

GMF32024ABTW, GMF32024BSLY, GMF32024HBTW, GMF32024HFTW, GMF64020ABTW

Driving voltage (VEE-VSS):

GMF32024JBTW, GMF32124JBTW, GMF32024JFTW, GMF32124JFTW, GMF32124KFTW

- Do not use the module in dewy, a lot of moisture, or other solutions.
- If even slight condensation occurs or splashes solutions at the terminals of LCD panel, electrochemical reactions will occur on the terminals, and terminal may be damaged and disconnected. Please note to prevent rapid temperature changes, because it may causes condensation.
- Do not touch the connector terminals, PWB, and electronic components when the LCD module is operating. Especially CCFL connectors are applied high voltage, and there is a danger of the electric shock.

Touching them may also cause malfunction of LCD module.

• Each product is designed to operate at specified driving duty ratio. If it is operated at a different duty ratio, it may be malfunction.

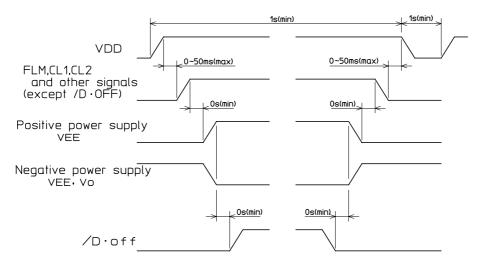
1/200 duty drive: GMF64020ABTW

1/240 duty drive: GMF32024ABTW, GMF32024BSLY, GMF32024HBTW, GMF32024HFTW, GMF32024JBTW, GMF32124JBTW, GMF32024JFTW.

GMF32024KFTW, GMF32124KFTW

•When LC panel is applied the DC voltage, its lifetime is shortened rapidly by electrochemical reaction. When using the GMF series LCD module, keep following power supply sequence to prevent the DC voltage being applied to the panel and to prevent the latch-up of CMOS-LSI in the module.

If the LC driving voltage or various signals are input before the logic power supply is stabilized, the internal LSI may be damaged due to floating or latch-up phenomena.



Installation precautions

- Do not remodel or disassemble the LCD module. If it malfunctions after being remodeled or disassembled and assembled again, Stanley electric is not liable for such malfunctions.
- Workers have to be grounded by such as earth-bands and put antistatic cloths, to prevent electrifying, because CMOS-LSI are used in the module.
- •The LCD module is designed to be installed using mounting holes at the four corners. Make sure that the display surface is completely flat after it is installed in position. When mounting and installing it, do not warp or twist it and do not apply stress to it. If it is warped or twisted or stress is applied to it, discoloring may occur, or the LCD may be damaged.
- •To protect the polarizer and the LC panel, install a protective panel, such as a clear acrylic plate. And keep a clearance between the protective panel and the module to prevent stress to the module.
- If dirt or dust enters the inside of the LCD module, the display quality may be adversely affected. If the LCD module is used in a dusty place, take precautionary measures to protect it from dust.
- The metal frame or plastic frame of module is not visual inspection subject. It might have some scratches. Please design to cover or conceal the metal frame or plastic frame when it is installed.
- •Lighting source such as CCFL/LED backlight in the module, is heated. To note the heat radiation and do not exceed the ambient temperature in the specification when it is operating.
- Do not arrange the parts which is damaged by light, because a LCD module has some light leaking at the back and side.
- GMF32024HBTW and GMF32024HFTW are available to exchange its CCFL. When you exchange the CCFL, please note handling and prevent CCFL cracking and impact to the module. And CCFL have to be exchanged after turn off the power supply, because it is applied high voltage.

GMF32024ABTW FG terminal or PWB's installation hole has to be grounded to prevent the LSI malfunction or damage by static electricity.

Precautions for safety

- •There might be some burr at the edge of the metal frame, be care of the injury.
- When designing of the installation, the cable for the connector must not come in contact with the metal part such as a metal frame.
- There is no protection circuit for short-circuit trouble in the module. For safety measures, please built in fuse or shut-down circuit in system power supply.

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